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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

TC 3-883

APPL NUM 10032687	FILING DATE 12/28/2001	CLASS 438	SUBCLASS 2842	GAU 2842	EXAMINER GUERRERO
**APPLICANTS: Kim Hyung; Lee Min; Son Kwon;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED: REPUBLIC OF KOREA 2001-75440 11/30/2001					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met: <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO 29936/38063	
Verified and Acknowledged Examiners's initials <i>MG</i>					
TITLE : Method of forming wiring in semiconductor devices					

U.S. DEPT. OF COMM /PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner	DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Applicati n Examiner	
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